

TOSHIBA CMOS Digital Integrated Circuit Silicon Monolithic

# TC74VHC373F, TC74VHC373FK

#### Octal D-Type Latch with 3-State Output

The TC74VHC373 is an advanced high speed CMOS OCTAL LATCH with 3-STATE OUTPUT fabricated with silicon gate  $C^2$ MOS technology.

It achieves the high speed operation similar to equivalent Bipolar Schottky TTL while maintaining the CMOS low power dissipation.

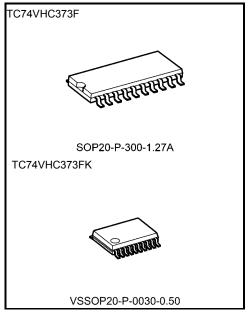
This 8-bit D-type latch is controlled by a latch enable input (LE) and an output enable input (  $\overline{OE}$  ).

When the  $\,\overline{\rm OE}\,$  input is high, the eight outputs are in a high impedance state

An input protection circuit ensures that 0 to 5.5 V can be applied to the input pins without regard to the supply voltage. This device can be used to interface 5 V to 3 V systems and two supply systems such as battery back up. This circuit prevents device destruction due to mismatched supply and input voltages.

#### **Features**

- High speed: tpd = 5.0 ns (typ.) at VCC = 5 V
- Low power dissipation: ICC = 4 μA (max) at Ta = 25°C
- High noise immunity: VNIH = VNIL = 28% VCC (min)
- Power down protection is provided on all inputs.
- Balanced propagation delays: tpLH ~ tpHL
- Wide operating voltage range: VCC (opr) = 2 to 5.5 V
- Low noise: VOLP = 0.8 V (max)
- Pin and function compatible with 74ALS373



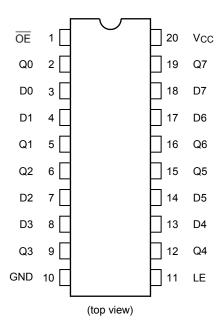
Weight

SOP20-P-300-1.27A : 0.22 g (typ.) VSSOP20-P-0030-0.50 : 0.03 g (typ.)

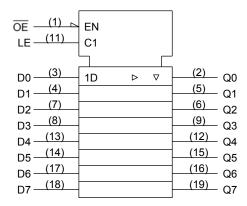
Start of commercial production 1991-05



#### **Pin Assignment**



## **IEC Logic Symbol**



#### **Truth Table**

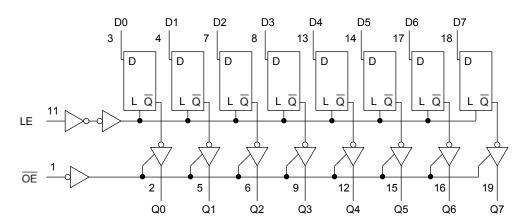
	Inputs		Output
ŌĒ	LE	D	Output
Н	Х	Х	Z
L	L	Х	Qn
L	Н	L	L
L	Н	Н	Н

X: Don't care

Z: High impedance

Qn: Q outputs are latched at the time when the LE input is taken to a low logic level.

### **System Diagram**





### **Absolute Maximum Ratings (Note)**

Characteristics	Symbol	Rating	Unit
Supply voltage range	Vcc	−0.5 to 7.0	V
DC input voltage	VIN	−0.5 to 7.0	V
DC output voltage	Vout	-0.5 to V <sub>CC</sub> + 0.5	V
Input diode current	lıĸ	-20	mA
Output diode current	Іок	±20	mA
DC output current	lout	±25	mA
DC Vcc/ground current	Icc	±75	mA
Power dissipation	PD	180	mW
Storage temperature	T <sub>stg</sub>	−65 to 150	°C

Note: Exceeding any of the absolute maximum ratings, even briefly, lead to deterioration in IC performance or even destruction.

Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings and the operating ranges.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

#### **Operating Ranges (Note)**

Characteristics	Symbol	Rating	Unit
Supply voltage	Vcc	2.0 to 5.5	V
Input voltage	V <sub>IN</sub>	0 to 5.5	V
Output voltage	Vout	0 to Vcc	V
Operating temperature	Topr	-40 to 85	°C
Input rise and fall time	dt/dv	0 to 100 (V <sub>CC</sub> = 3.3 ± 0.3 V) 0 to 20 (V <sub>CC</sub> = 5 ± 0.5 V)	ns/V

Note: The operating ranges must be maintained to ensure the normal operation of the device.

Unused inputs must be tied to either VCC or GND.



#### **Electrical Characteristics**

#### **DC Characteristics**

Characteristics	Symbol	Test Condition		Ta = 25°C		Ta = -40 to 85°C		Unit		
Similar Control Control				V <sub>CC</sub> (V)	Min	Тур.	Max	Min	Max	
High-level input				2.0	1.50	_	_	1.50	-	
voltage	VIH	-	_	3.0 to 5.5	V <sub>CC</sub> × 0.7	I	_	V <sub>CC</sub> × 0.7	ı	V
Low-level input				2.0	1	1	0.50	-	0.50	
voltage	VIL	-	_	3.0 to 5.5	_	_	V <sub>CC</sub> × 0.3	_	V <sub>CC</sub> × 0.3	V
				2.0	1.9	2.0	_	1.9	_	
		.,	I <sub>OH</sub> = -50 μA	3.0	2.9	3.0	_	2.9	_	V
High-level output voltage	Voн	VIN = V <sub>IH</sub> or V <sub>IL</sub>		4.5	4.4	4.5	_	4.4	_	
Vollago			$I_{OH} = -4 \text{ mA}$	3.0	2.58		_	2.48	_	
			$I_{OH} = -8 \text{ mA}$	4.5	3.94	_	_	3.80	_	
	VoL	VIN = V <sub>IH</sub> or V <sub>IL</sub>	I <sub>OL</sub> = 50 μA	2.0	_	0.0	0.1	_	0.1	V
				3.0	_	0.0	0.1	_	0.1	
Low-level output voltage				4.5	_	0.0	0.1	_	0.1	
voltage			I <sub>OL</sub> = 4 mA	3.0	_	_	0.36	_	0.44	
			$I_{OL}$ = 8 mA	4.5	_	_	0.36	_	0.44	
3-state output off- state current	loz	VIN = VIH or VIL VOUT = VCC or GND		5.5	_	_	±0.25	_	±2.50	μΑ
Input leakage current	I <sub>IN</sub>	V <sub>IN</sub> = 5.5 V or GND		0 to 5.5	_	_	±0.1	_	±1.0	μΑ
Quiescent supply current	Icc	V <sub>IN</sub> = V <sub>CC</sub> or GND		5.5	_	_	4.0	_	40.0	μΑ

## Timing Requirements (input: tr = tf = 3 ns)

Characteristics	Symbol	Test Condition	Ta = 25°C		Ta = -40 to 85°C	Unit	
			V <sub>CC</sub> (V)	Тур.	Limit	Limit	
Minimum pulse width (LE)	t <sub>w (H)</sub>	_	$3.3 \pm 0.3$ $5.0 \pm 0.5$	_ _	5.0 5.0	5.0 5.0	ns
Minimum set-up time	ts	_	$3.3 \pm 0.3$ $5.0 \pm 0.5$	_	4.0 4.0	4.0 4.0	ns
Minimum hold time	th	_	$3.3 \pm 0.3$ $5.0 \pm 0.5$	_ _	1.0 1.0	1.0 1.0	ns



#### AC Electrical Characteristics (input: tr = tf = 3 ns)

Characteristics	Symbol	Test Condition			Ta = 25°C			Ta = -40 to 85°C		Unit
	- J		V <sub>CC</sub> (V)	C <sub>L</sub> (pF)	Min	Тур.	Max	Min	Max	0
			00.00	15	_	7.0	11.0	1.0	13.0	
Propagation delay time	tpLH		$3.3 \pm 0.3$	50	_	9.5	14.5	1.0	16.5	
(LE-Q)	tpHL	_	5.0 ± 0.5	15	_	4.9	7.2	1.0	8.5	ns
			5.0 ± 0.5	50	_	6.4	9.2	1.0	10.5	
			3.3 ± 0.3	15	_	7.3	11.4	1.0	13.5	
Propagation delay time	tpLH		3.3 ± 0.3	50	-	9.8	14.9	1.0	17.0	
(D-Q)	tpHL	_	5.0 ± 0.5	15	-	5.0	7.2	1.0	8.5	ns -
				50	-	6.5	9.2	1.0	10.5	
	t <sub>P</sub> ZL t <sub>P</sub> ZH	R <sub>L</sub> = 1 kΩ	3.3 ± 0.3	15	-	7.3	11.4	1.0	13.5	- ns
3-state output enable				50	-	9.8	14.9	1.0	17.0	
time			5.0 ± 0.5	15	-	5.5	8.1	1.0	9.5	
				50	-	7.0	10.1	1.0	11.5	
3-state output disable	t <sub>pLZ</sub>	D 410	$3.3 \pm 0.3$	50	-	9.5	13.2	1.0	15.0	
time	t <sub>pHZ</sub>	$R_L = 1 k\Omega$	5.0 ± 0.5	50	-	6.5	9.2	1.0	10.5	ns
0.4	t <sub>osLH</sub>	(N-4-4)	$3.3 \pm 0.3$ $5.0 \pm 0.5$	50	-	_	1.5	-	1.5	
Output to output skew	tosHL	(Note 1)		50	_	_	1.0	_	1.0	ns
Input capacitance	C <sub>IN</sub>		_		_	4	10	_	10	pF
Output capacitance	Cout		_		-	6	-	1	_	pF
Power dissipation capacitance	C <sub>PD</sub>			(Note 2)	_	27	_	_	_	pF

Note 1: Parameter guaranteed by design.

tosLH = |tpLHm - tpLHn|, tosHL = |tpHLm - tpHLn|

Note 2: CPD is defined as the value of the internal equivalent capacitance which is calculated from the operating current consumption without load.

Average operating current can be obtained by the equation:

ICC (opr) = CPD·VCC·fIN + ICC/8 (per latch)

And the total CPD when n pcs. of Latch operate can be gained by the following equation:

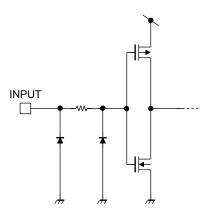
CPD (total) = 14 + 13·n



## Noise Characteristics (input: tr = tf = 3 ns)

Characteristics	Cumbal	Test Condition	Ta =	Unit		
Characteristics	Symbol		V <sub>CC</sub> (V)	Тур.	Max	Offic
Quiet output maximum dynamic V <sub>OL</sub>	VOLP	C <sub>L</sub> = 50 pF	5.0	0.5	8.0	V
Quiet output minimum dynamic V <sub>OL</sub>	Volv	C <sub>L</sub> = 50 pF	5.0	-0.5	-0.8	V
Minimum high level dynamic input voltage	V <sub>IHD</sub>	C <sub>L</sub> = 50 pF	5.0	_	3.5	V
Maximum low level dynamic input voltage	V <sub>ILD</sub>	C <sub>L</sub> = 50 pF	5.0	_	1.5	V

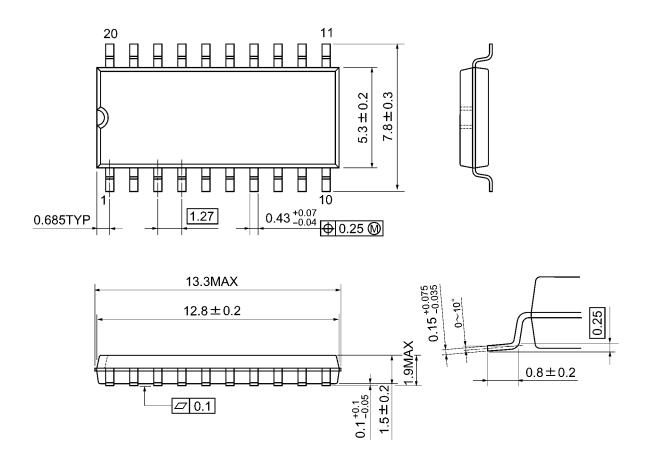
# **Input Equivalent Circuit**





## **Package Dimensions**

SOP20-P-300-1.27A Unit: mm



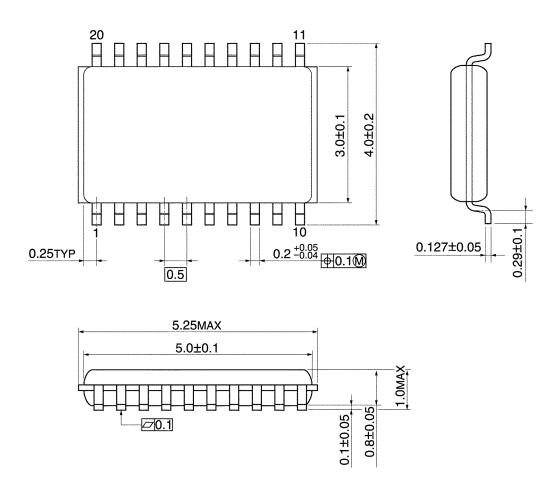
Weight: 0.22 g (typ.)

2019-01-31



## **Package Dimensions**

VSSOP20-P-0030-0.50 Unit: mm



Weight: 0.03 g (typ.)



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